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Signed: Stephen E. Baldwin Date: April 29, 1998

Stephen E. Baldwin, Reg. No. 27,769



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor: Pedersen et al

Serial No.: 08/834,798

Filed: 04/07/97 ²

For: CONDUCTIVE EPOXY FLIP-CHIP

Art Unit: 2103

Examiner: SPARKS, D.

RECEIVED

MAY 06 1998

GROUP 2100

AMENDMENT A

Assistant Commissioner for Patents
Washington, D. C. 20231

Sir:

This Amendment A is submitted in response to the Office Action mailed November 3, 1997 and is being submitted on or before the current due date of May 3, 1998.

AMENDMENTS

IN THE SPECIFICATION:

At page 1, change the title of the application to read as follows:

-- A Conductive Epoxy Flip-Chip Package and Method--

J. Markley
S-6-98

6/12
J. Markley
S-6-98

b